-KA	MAY	А ОНМ			
				No.: Date:	RCC-K-HTS-0001 /8
			Data s	sheet	
-	Title:	FIXED THIC	CK FILM CHIP RE	SISTORS;REC	TANGULAR TYPE AND
-	Style:	RCC10,1	6,20,32		
	Ν	Note: • Stock con Temperate Relative h The period • Product s time witho • If you hav	ure: +5°C ~ +35°C numidity: 25% ~ 75% d of guarantee: Withir Solde specification contain out notice	ntimony Fre a 2 year from shipr erability shall be sa hed in this data s a Purchasing Sp	ee men t by the company. atisfied. sheet are subject to change at a pecification for any quality
				釜屋電 KAMAYA	КаранаКаранаHokkaido Research CenterApproval by: Т. SannomiyaDrawing by: М. Shibuya

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM Title: RCC10,16,20,32

Page: 1/13

/8

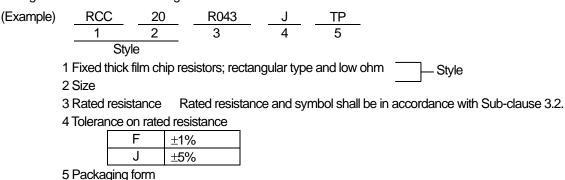
1. Scope

- 1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type and low ohm, style of RCC10,16,20,32.
- 1.2 Applicable documents

JIS C 5201-1: 2011, JIS C 5201-8: 2014, JIS C 5201-8-1: 2014 IEC60115-1: 2008, IEC60115-8: 2009, IEC60115-8-1: 2014 EIAJ RC-2144C-2010

2. Classification

Type designation shall be the following form.



В	Bulk (loose package)	
TH	Den en ten in n	
TP	Paper taping	

Product specification contained in this data sheet are subject to change at any time without notice.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff. Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM RCC10,16,20,32

Page: 2/13

/8

3. Rating

3.1 The ratings shall be in accordance with Table-1.

			Table-1		
Style	Rated dissipation (W)	Rated current	Temperature coefficient of resistance (10 ⁻⁶ / °C)	Rated resistance	Tolerance on rated resistance
	uissipation (VV)	range (A)		range(Ω)	Tesisiance
			±150	0.051~0.1	
RCC10	0.125	1.11~2.5	0~+350	0.025~0.05	F(±1%), J(±5%)
			0~+800	0.02~0.024	
			±150	0.051~0.1	
RCC16	0.25	1.58~5.0	0~+250	0.033~0.05	F(±1%), J(±5%)
			0~+350	0.01~0.03	
			±100	0.051~0.1	
RCC20	0.33	1.81~5.74	±150	0.03~0.05	F(±1%), J(±5%)
			0~+250	0.01~0.027	
DOCOO	0.5		±100	0.036~0.1	
RCC32	0.5	2.23~5.0	0~+250	0.02~0.033	F(±1%), J(±5%)

. .

Style	Insulation voltage (V)	Category temperature range (°C)	
RCC10	100	-55~+155	
RCC16	100		
RCC20	500	-55~+155	
RCC32	500		

3.2 Rated resistance

The rated resistance shall be in accordance with Table-2

Table-2 Rated resistance Rated resistance Rated resistance Marking symbol Symbol Marking symbol Symbol Marking symbol Symbol $[m\Omega]$ $[m\Omega]$ $[m\Omega]$ 10 R010 010 39 R039 039 68 R068 068 R015 R040 040 R070 15 015 40 70 070 20 020 43 R043 043 75 R075 075 R020 22 R022 022 47 R047 047 80 R080 080 24 R024 024 50 R050 050 82 R082 082 25 R025 025 R051 051 R090 51 90 **9**0 27 R027 027 56 R056 056 91 R091 091 30 R030 030 60 R060 060 100 R100 R10 33 033 R062 062 R033 62 R036 036 R065 065 36 65

3.3 Climatic category

55/155/56

Lower category temperature	–55 °C
Upper category temperature	+155 ℃
Duration of the damp heat, steady state test	56days

Product specification contained in this data sheet are subject to change at any time without notice.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.

Issue: KÁMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM RCC10,16,20,32

Page: 3/13

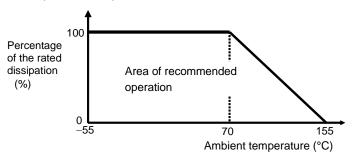
3.4 Stability class

5%

Limits for change of resistance: –for long–term tests ±5% –for short–term tests ±1%

3.5 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.



Figure–1 Derating curve

3.6 Rated voltage

d.c. or a.c. r.m.s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

3.7 Rated current

The rated current calculated from the square root of the quotient of the rated resistance and the rated dissipation.

 $I = \sqrt{P / R}$

I: Rated current (A) P: Rated dissipation (W) R: Rated resistance (Ω)

The rated current shall be corresponding to rated voltage.

4. Packaging form

The standard packaging form shall be in accordance with Table-3.

Table-3						
Symbol	Pac	kaging form	Standard packaging quantity / units	Application		
В	Bulk (loose package)		1,000 pcs.	RCC10,16,20,32		
TH	Paper taping 8mm width, 2mm pitches		10,000 pcs.	RCC10		
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RCC16, 20, 32		

Product specification contained in this data sheet are subject to change at any time without notice.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.

Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM RCC10,16,20,32

Page: 4/13

/8

5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-4.

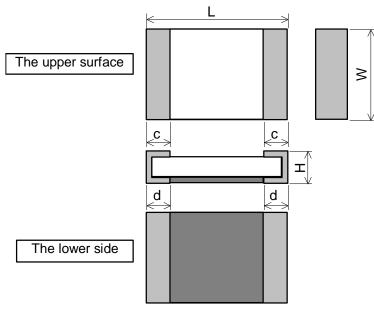




Table-4U						
Style	Rated resistance range	L	W	Н	С	d
RCC10	All resistance range	1.0±0.05	0.5±0.05	0.35 +0.05	0.25 +0.05	0.25 +0.05
RCC16	20mΩ≤R	1.6±0.1	0.8 ^{+0.15}	0.5±0.1	0.3±0.1	0.3±0.1
	R<20mΩ					0.55±0.10
RCC20	20mΩ≤R	2.0+0.15	1.25±0.10	0.6 + 0.1	0.4+0.2	0.4±0.2
RCC20	R<20mΩ	2.0±0.15	1.25±0.10	0.0±0.1	0.4±0.2	0.6±0.2
RCC32	All resistance range	3.1±0.2	1.6±0.15	0.6±0.1	0.5±0.25	0.5±0.25

5.2 Net weight (Reference)

Style	Net weight (mg)
RCC10	0.6
RCC16	2
RCC20	5
RCC32	9

6. Marking

The rated resistance of marking symbol of Sub-clause 3.2 shall be marked on substrate side.

The Rated resistance of RCC10 and RCC16 should not be marked.

(Example) "050" \rightarrow 0.05 [Ω] \rightarrow 50m Ω (Application: 10m Ω \rightarrow 91m Ω)

"■90" \rightarrow 0.09 [Ω] \rightarrow 90mΩ (Application: 90mΩ only)

"R10" \rightarrow 0.1 [Ω] \rightarrow 100m Ω (Application: 100m Ω or above

Product specification contained in this data sheet are subject to change at any time without notice.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff. Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM Title: RCC10,16,20,32

Page: 5/13

7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201-1: 2011.

7.2 The performance shall be satisfied in Table-5.

No.	Test items	Table– 5(1) Condition of test (JIS C 5201–1)	Performance requirements
1	Visual examination	Sub-clause 4.4.1 Checked by visual examination.	As in 4.4.1 The marking shall be legible, as checked by visual examination.
2	Dimension	Sub-clause 4.4.2	As specified in Table-4 of this specification.
	Resistance	Sub-clause 4.5 Measurement current: 1(A) Note: The measuring apparatus corresponding to DC Low-ohm Mater (1A) of AX-1152D for ADEX CORPORATION.	As in 4.5.2 The resistance value shall correspond with the rated resistance taking into account the specified tolerance.
3	Voltage proof	Sub-clause 4.7 Method: 4.6.1.4(See Figure-5) Test voltage: Alternating voltage with a peak value of 1.42 times the insulation voltage. Duration: 60 s±5 s Insulation resistance Test voltage: Insulation voltage Duration: 1 min.	No breakdown or flash over $R \ge 1 \ G \Omega$
4	Solderability	Sub-clause 4.17 Without aging Flux: The resistors shall be immersed in a non-activated soldering flux for 2 s. Bath temperature: 235 °C±5 °C Immersion time: 2 s±0.5 s	As in 4.17.4.5 The terminations shall be covered with a smooth and bright solder coating.
5	Mounting Overload (in the mounted state) Solvent resistance of the marking	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure-3 Sub-clause 4.13 The applied voltage shall be 2.5 times the rated voltage or the current corresponding to. Duration: 2 s Visual examination Resistance Sub-clause 4.30 Solvent: 2-propanol Solvent temperature: 23 °C±5 °C Method 1 Rubbing material: cotton wool Without recovery	No visible damage ∆R ≤ ±1% Legible marking
6	Mounting Bound strength of the end face plating	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure-4 Sub-clause 4.33 Bent value: 3 mm Resistance	ΔR ≤ ±1%
	Final measurements	Sub-clause 4.33.6 Visual examination	No visible damage

Product specification contained in this data sheet are subject to change at any time without notice.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff. Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

/8

No: RCC-K-HTS-0001

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM RCC10,16,20,32

Page: 6/13

		Table–5(2)	
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
7	Resistance to soldering heat	Sub-clause 4.18 (JEITA RC-2144 2.3.2) T ₁ :Pre-heat minimum temp.:150 \pm 5 °C T ₂ :Pre-heat maximum temp.:180 \pm 5 °C T ₃ :Soldering temp.:220 °C T ₄ :Peak temp.:250 °C t ₁ :Pre-heat duration:120 \pm 5 s t ₂ :Soldering duration:60 to 90 s t ₃ :Peak duration(T ₄ -5°C):20 to 40 s Pre-reflow soldering: 1 time (Initial measurements) Reflow soldering: 3 times T ₄ T ₁ T ₁ T ₁ T ₁ T ₁	
	Component solvent resistance	Visual examination Resistance Sub-clause 4.29 Solvent: 2-propanol Solvent temperature: 23 °C±5 °C Method 2 Recovery: 48 h Visual examination Resistance	No visible damage $\Delta R \le \pm 1\%$ No visible damage $\Delta R \le \pm 1\%$
8	Mounting	Sub-clause 4.31	
	Adhesion	Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub–clause 4.32 Force: 5 N Duration: 10 s±1 s Visual examination	No visible damage
	Rapid change temperature	Sub-clause 4.19 Lower category temperature: -55 °C Upper category temperature: +155 °C Duration of exposure at each temperature: 30 min. Number of cycles: 5 cycles. Visual examination Resistance	No visible damage $\Delta R \le \pm 1\%$

Product specification contained in this data sheet are subject to change at any time without notice.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff. Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

/8

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM

RCC10,16,20,32

Page: 7/13

/8

		Table–5(3)	
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
9	Climatic sequence –Dry heat	Sub–clause 4.23 Sub–clause 4.23.2 Test temperature: +155 °C	
	–Damp heat, cycle (12+12hour cycle) First cycle	Duration: 16 h Sub-clause 4.23.3 Test method: 2 Test temperature: 55 °C [Severity(2)]	
	-Cold	Sub–clause 4.23.4 Test temperature –55 °C Duration: 2h	
	–Damp heat, cycle (12+12hour cycle) Remaining cycle	Sub-clause 4.23.6 Test method: 2 Test temperature: 55 °C [Severity (2)] Number of cycles: 5 cycles	
	–D.C. load	Sub-clause 4.23.7 The applied current shall be the rated current. Duration: 1 min. Visual examination Resistance	No visible damage $\Delta R \leq \pm 5$ %
10	Mounting Endurance at 70 °C	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.25.1 Ambient temperature: 70 °C±2 °C Duration: 1000 h The current shall be applied in cycles of 1.5 h on and 0.5 h. The applied current shall be the rated current Examination at 48 h, 500 h and 1000 h: Visual examination Resistance	No visible damage ∆R ≤ ±5 %

Product specification contained in this data sheet are subject to change at any time without notice. If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff. Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

No: RCC-K-HTS-0001

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM RCC10,16,20,32

Page: 8/13

		Table-5(4)	
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
11	Mounting Variation of resistance with	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure-3 Sub-clause 4.8	As in Table–1
	temperature	+20 °C / +155 °C	
12	Mounting Damp heat, steady state	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure-3 Sub-clause 4.24 Ambient temperature: 40 °C \pm 2 °C Relative humidity: 93 \pm^2_3 % Without current applied. Visual examination Resistance	No visible damage Legible marking $\Delta R \leq \pm 5\%$
13	Dimensions (detail) Mounting Endurance at upper category temperature	Sub-clause 4.4.3 Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure-3 Sub-clause 4.25.3 Ambient temperature:155 °C±2 °C Duration: 1000 h Examination at 48 h, 500 h and 1000 h: Visual examination Resistance	As in Table–4 No visible damage $\Delta R \leq \pm 5\%$

/8

Product specification contained in this data sheet are subject to change at any time without notice. If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff. Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

No: RCC-K-HTS-0001

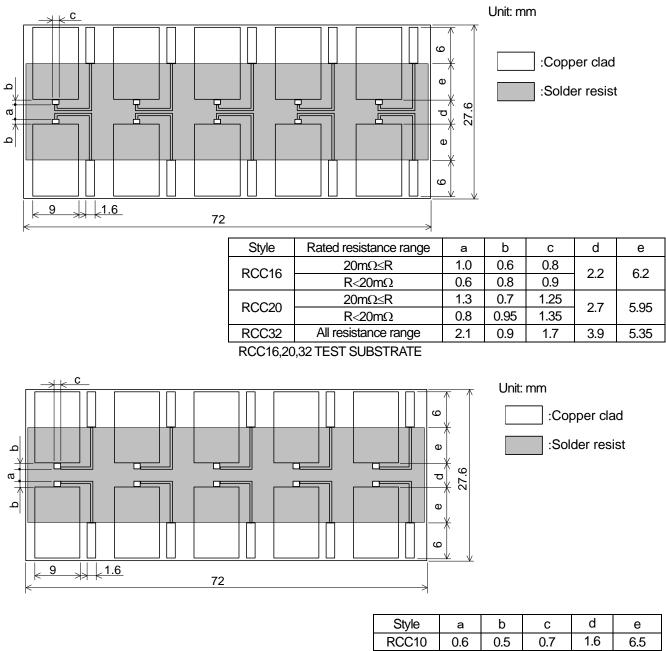
FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM RCC10,16,20,32

Page: 9/13

/8

8. Test substrate

Title:



RCC10 TEST SUBSTRATE

Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm

2). In the case of connection by connector, the connecting terminals are gold plated.

However, the plating is not necessary when the connection is made by soldering.

Figure-3

Product specification contained in this data sheet are subject to change at any time without notice.

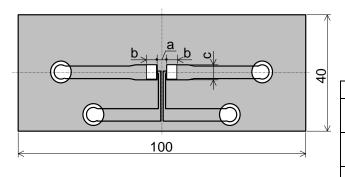
If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff. Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

:Copper clad

FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM Title:

RCC10,16,20,32

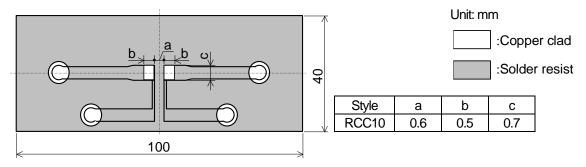
Page: 10/13



:Solder resist						
Style	Rated resistance range	а	b	С		
RCC16	20mΩ≤R	1.0	0.6	0.8		
	R<20mΩ	0.6	0.8	0.9		
RCC20	20mΩ≤R	1.3	0.7	1.25		
	R<20mΩ	0.8	0.95	1.35		
RCC32	All resistance range	2.1	0.9	1.7		

Unit: mm

RCC16.20.32 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

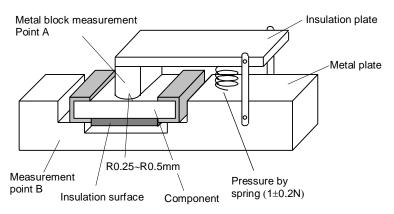


RCC10 BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE Remark 1). Material: Epoxide woven glass

Thickness: 1.6mm Thickness of copper clad: 0.035mm

Figure-4





· RCC10

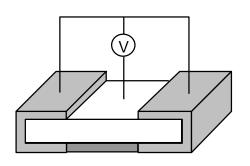


Figure-5

Product specification contained in this data sheet are subject to change at any time without notice.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff. Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

No: RCC-K-HTS-0001 /8

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM RCC10,16,20,32

Page: 11/13

9. Taping

9.1 Applicable documents JIS C 0806–3: 2014, EIAJ ET–7200C: 2010

9.2 Taping dimensions

9.2.1 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-6 and Table-6.

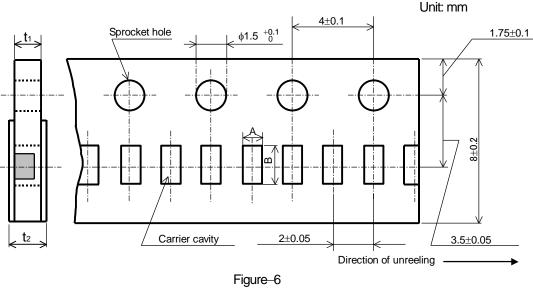


		Table-6		Unit: mm
Style	A	В	t 1	t 2
RCC10	$0.65 \begin{array}{c} +0.05 \\ -0.10 \end{array}$	1.15 ^{+0.05} _0.10	0.4 ± 0.05	0.5max.

9.2.2 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-7 and Table-7.

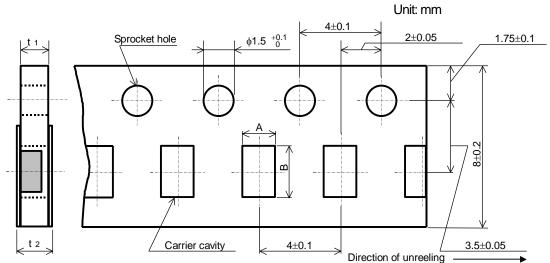


Figure-	-7
---------	----

		Table-7		Unit: mm
Style	A	В	t 1	t 2
RCC16	1.15±0.15	1.9 ± 0.2	0.6 ± 0.1	0.8max.
RCC20	1.65±0.15	2.5 ± 0.2	0.8 ± 0.1	1.0max.
RCC32	2.00±0.15	3.6 ± 0.2	0.0 ± 0.1	T.UMAX.

Product specification contained in this data sheet are subject to change at any time without notice.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.

Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

No: RCC-K-HTS-0001 /8

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM RCC10,16,20,32

Page: 12/13

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.

KAMAYA OHM

- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RCC 10: Figure–8, RCC16,20,32: Figure–9.
- 6). When the tape is bent with the minimum radius for 25mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

The maximum number of missing components shall be one or 0.1%, whichever is greater.

8). The resistors shall be faced to upward at the substrate side in the carrier cavity.

Reel dimensions shall be in accordance with the following Figure-10 and Table-8.

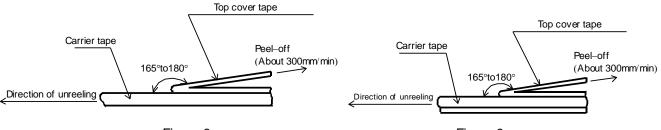
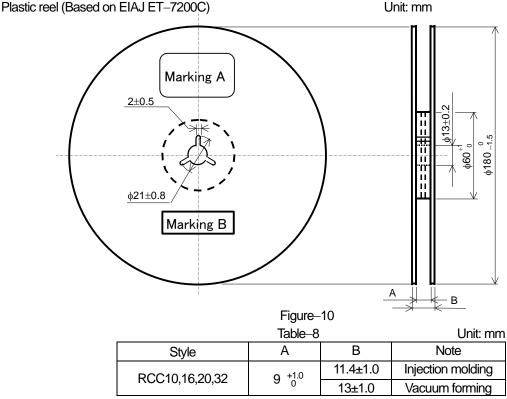


Figure-8

Figure-9

9.3 Reel dimension



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

Product specification contained in this data sheet are subject to change at any time without notice.

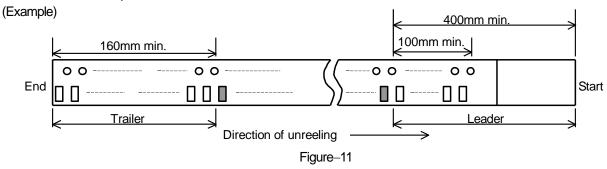
If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.

Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5

Title: FIXED THICK FILM CHIP RESISTORS; RECTANGULAR TYPE AND LOW OHM RCC10,16,20,32

Page: 13/13

9.4 Leader and trailer tape.



10. Marking on package

The label of a minimum package shall be legibly marked with follows.

10.1 Marking A

(1) Classification (Style, Rated resistance, Tolerance on rated resistance, Packaging form) (2) Quantity

(3) Lot number (4) Manufacturer's name or trade mark (5) Others

10.2 Marking B (KAMAYA control label)

Product specification contained in this data sheet are subject to change at any time without notice.

If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff. Issue: KAMAYA ELECTRIC CO., LTD. Research & Development Department HOKKAIDO Research center Last update: 2023.1.5